October 2001

FDS6894A

Dual N-Channel Logic Level PWM Optimized PowerTrench[®] MOSFET

General Description

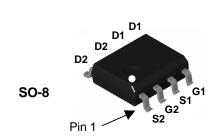
These N-Channel Logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

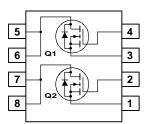
These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

• 8 A, 20 V.

- Low gate charge (17 nC)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DSS}	Drain-Sour	ce Voltage		20	V
V _{GSS}	Gate-Source Voltage			± 8	V
I _D	Drain Current – Continuous		(Note 1a)	8	А
	– Pulsed			32	
P _D	Power Dissipation for Dual Operation			2	W
	Power Dissipation for Single Operation (Note			1.6	
			(Note 1b)	1	
			(Note 1c)	0.9	
T _J , T _{STG}	Operating a	Ind Storage Junction Temp	erature Range	-55 to +150	°C
Therma	I Charac	teristics			
R _{0JA}	Thermal Re	sistance, Junction-to-Ambi	ient (Note 1a)	78	°C/W
R _{θJC}	Thermal Re	Thermal Resistance, Junction-to-Case		40	°C/W
Packag	e Markin	g and Ordering I	nformation		
Device Marking		Device	Reel Size	Tape width	Quantity
FDS6894A		FDS6894A	13"	12mm	2500 units

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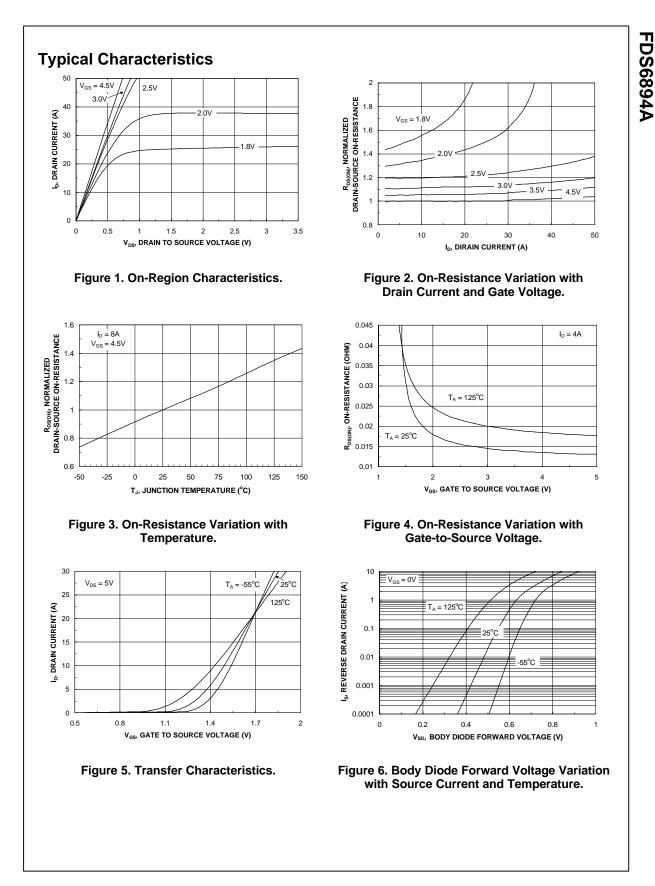
FDS6894A Rev C (W)

FDS6894A

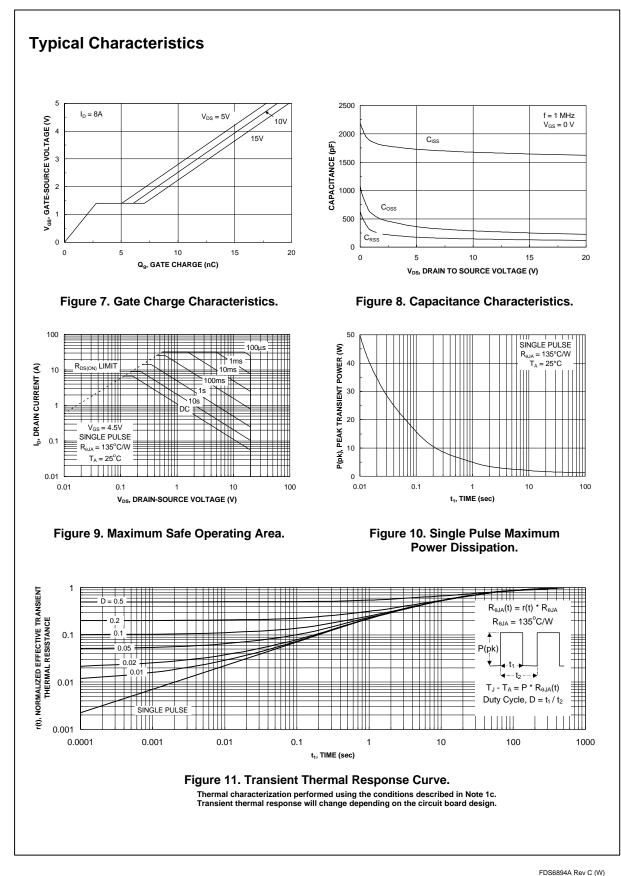
	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C		13		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$			1 10	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = - 8 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6	0.8	1.5	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, I_D = 8 \ A \\ V_{GS} = 2.5 \ V, I_D = 7 \ A \\ V_{GS} = 1.8 \ V, I_D = 6 \ A \\ V_{GS} = 4.5 \ V, I_D = 8 \ A, T_J = 125^\circ C \end{array} $		13 16 21 18	17 20 30 25	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5V, V_{DS} = 5V$	16			Α
g fs	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 8 A$		44		S
Dvnamio	Characteristics	· ·			•	•
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		1676		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		288		pF
C _{rss}	Reverse Transfer Capacitance	Transfer Capacitance		146		pF
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 \text{ V}, I_D = 1 \text{ A},$		10	20	ns
t _r	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$		14	25	ns
t _{d(off)}	Turn–Off Delay Time	7		33	53	ns
t _f	Turn–Off Fall Time	7		12	22	ns
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, I_D = 8 \text{ A},$		17	24	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		2.8		nC
Q _{gd}	Gate-Drain Charge			3.3		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 1.3 A$ (Note 2)		0.7	1.2	V

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDS6894A Rev C (W)



FDS6894A Rev C (W)



FDS6894A

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